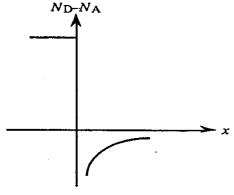
CHAPTER 7

7.1

(a) The in and out movement of the majority carriers about the steady-state depletion width in response to the applied a.c. signal.

(b)



(c) Quasistatically is an adverb used to describe a situation where carriers or a device subject to non-steady-state conditions responds as if steady-state conditions applied at each instant of time.

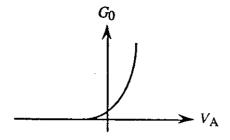
(d) Varactor—a contraction of variable reactor. A commercial device, such as a reverse-biased pn junction diode, where the reactance = $1/j\omega C$ varies as a function of the applied voltage.

(e) Profiling—the process of determining the doping concentration inside a device as a function of position.

(f) The low-frequency conductance of an ideal diode was noted to be (Eq. 7.15),

$$G_0 = \frac{q}{kT}(I + I_0)$$

 $G_0 \propto I$ when the diode is forward biased and vanishes for reverse biases greater than a few kT/q. Also note that $G_0 = qI_0/kT$ when $V_A = 0$. We conclude



- (g) The diffusion admittance arises from fluctuations in the number and position of minority carriers stored in the quasineutral regions adjacent to the depletion region.
- (h) At signal frequencies where $\omega \tau_p \gtrsim 1$, the minority carriers have trouble following the a.c. signal and the resulting out-of-phase oscillations enhance the diffusion conductance at the expense of the diffusion capacitance.

7.2 Given

$$N_{\rm R}(x) = N_{\rm D}(x) = bx^m \qquad \dots x > 0$$

the application of the depletion approximation yields

$$\rho \equiv qN_{\rm D} = qbx^m \qquad \dots 0 \le x \le x_{\rm n} \cong W$$

Next substituting into Poisson's equation gives

$$\frac{d\mathcal{E}}{dx} = \frac{\rho}{K_{S}\varepsilon_{0}} = \frac{qb}{K_{S}\varepsilon_{0}}x^{m} \qquad \dots 0 \le x \le W$$

Separating variables and solving for the electric field, we find

$$\int_{\mathcal{E}(x)}^{0} d\mathcal{E}' = \int_{x}^{w} \frac{qb}{K_{S}\varepsilon_{0}} x'^{m} dx'$$

OF

$$-\mathcal{E}(x) = \frac{dV}{dx} = \frac{qb}{K_S \varepsilon_0} \frac{(x')^{m+1}}{m+1} \bigg|_x^W = \frac{qb}{(m+1)K_S \varepsilon_0} (W^{m+1} - x^{m+1})$$

Again separating variables and this time integrating across the entire depletion region, we obtain

$$\int_{0}^{V_{bi}-V_{A}} dV = \frac{qb}{(m+1)K_{S}\varepsilon_{0}} \int_{0}^{W} [W^{m+1} - x^{m+1}] dx$$

Or

$$V_{\text{bi}} - V_{\text{A}} = \frac{qb}{(m+1)K_{\text{S}}\varepsilon_{0}} \left[W^{m+1}x - \frac{x^{m+2}}{m+2} \right]_{0}^{W}$$

Note that the second term on the right hand side of the V_{bi} - V_A expression blows up when evaluated at the lower limit if m < -2. The solution likewise blows up at the upper limit if m = -2. It is for this reason that we must restrict m to values m > -2. With m > -2, we conclude

$$V_{\text{bi}}-V_{\text{A}} = \frac{qb}{(m+1)K_{\text{S}}\varepsilon_{0}} \left[W^{m+2} - \frac{W^{m+2}}{m+2} \right] = \frac{qb}{(m+2)K_{\text{S}}\varepsilon_{0}} W^{m+2}$$

$$W = \left[\frac{(m+2)(K_{\text{S}}\varepsilon_{0})}{qb} \left(V_{\text{bi}} - V_{\text{A}} \right) \right]^{1/(m+2)}$$

<u>7.3</u>

OI

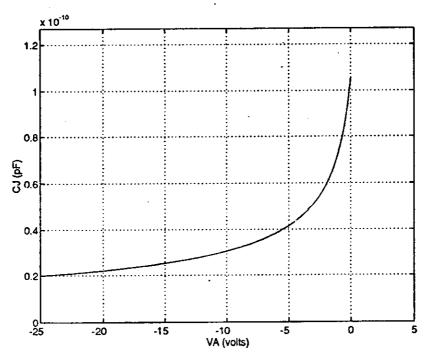
(a)/(b) Script of a MATLAB program yielding fully-dimensioned reverse-bias C-V curves, and a sample output to be compared with Fig. 7.3, are reproduced below. Using a computed $V_{\rm bi}$ consistent with the specified doping yields capacitance values that are too low. This is especially true 2t small applied voltages where IV_AI is comparable to $V_{\rm bi}$. For example, at $V_A = 0$, the computed C_I is 106 pF while the observed value is approximately 123 pF. The noted discrepancy is indeed related to the result in Exercise 7.2 where a lower $V_{\rm bi}$, a $V_{\rm bi}$ not consistent with the doping concentration, was deduced from the Fig. 7.3 experimental data. Not surprisingly, if one employs the $V_{\rm bi}$ deduced in Exercise 7.2 instead of the computed value (which is possible with the supplied m-file), one obtains excellent agreement with the Fig. 7.3 data. (It should be noted that even better agreement is obtained if 2 pF are added to the computed values to account for stray capacitance.)

(c) Because the depletion width at a given reverse bias shrinks with increased doping, the capacitance, which is proportional to 1/W, increases with increased doping on the lightly doped side of the junction. This is readily verified by simply running the P_07_03.m program with different N_D inputs.

MATLAB program script...

% Fully-dimensioned Reverse-bias C-V curves
% appropriate for p+-n step junction diodes
%Initialization
clear; close
%Constants and Parameters
q=1.6e-19; e0=8.85e-14;
EG=1.12; kT=0.0259;
ni=1.0e10; KS=11.8;

```
s=menu('CHOOSE Vbi APPROACH','Compute','Input');
A=input('Input the diode area in cm^2, A = ');
ND=input('Input the n-side (of p+-n) doping, ND = ');
VAmax=input('Input reverse-bias |VA|max, |VA|max = ');
           Vbi=EG/2+kT*log(ND/ni);
if s==1,
           Vbi=input('Input Vbi, Vbi = ');
else
end
%C-V Computation
VA=linspace(0,-VAmax);
CJ0=(KS*e0*A)/sqrt(2*KS*e0*Vbi/(q*ND));
CJ=CJ0./sqrt(1-VA/Vbi);
%Plot result
ymax=1.2*max(CJ);
plot (VA, CJ);
axis([-VAmax, 5, 0, ymax]); grid
xlabel('VA (volts)'); ylabel('CJ (pF)')
```



7.4

For an abrupt p^+ -n junction, we know in general from Eq. (7.11) that

$$\frac{1}{C_{\rm J}^2} = \frac{2}{qN_{\rm D}K_{\rm S}\varepsilon_0 A^2} (V_{\rm bi} - V_{\rm A})$$

After reducing all capacitance values in Table P7.4 by 3pF to account for the stray capacitance shunting the encapsulated diode[†], a least squares fit to the corrected data employing the MATLAB polyfit function yields

$$\frac{1}{C_I^2} = (8.254 \times 10^{20}) - (1.123 \times 10^{21})V_A \qquad \dots C_J \text{ in Farads}$$

We therefore conclude

$$N_{\rm D} = \frac{2}{qK_{\rm S}\varepsilon_0 A^2|\text{slopel}} = \frac{2}{(1.6\times10^{-19})(11.8)(8.85\times10^{-14})(6\times10^{-3})^2(1.123\times10^{21})}$$
$$= 2.96 \times 10^{14}/\text{cm}^3$$

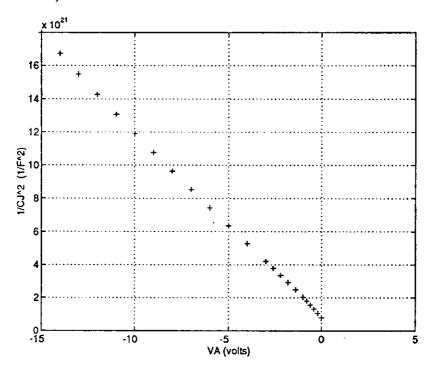
and

$$V_{\rm bi} = \frac{8.254 \times 10^{20}}{1.123 \times 10^{21}} = 0.735 \text{ V}$$

Referring to Fig. E5.1, one finds the $V_{\rm bi}$ result here is reasonably close to the theoretically computed $V_{\rm bi} = 0.83 \, \rm V$ associated with an $N_{\rm D} \equiv 3 \times 10^{14} / \rm cm^3$ p^+ -n step junction.

[†] It was incorrectly stated in the first printing of the text that the data listed in Table P7.4 had already been corrected to account for the cited stray capacitance.

A plot of the corrected $1/C_J^2$ versus V_A data, which may be used for obtaining a result by "eyeballing," is displayed below. (Also see m-file P_07_04.m available on the instructor's disk.)



7.5 For concreteness, we take the device under test to be a p^+ -n junction diode, with $N_D(x)$ the arbitrary nondegenerate donor doping on the lightly doped side of the junction. Based on the depletion approximation, the total charge in the depletion region on the n-side of the

$$Q_{N} = A \int_{0}^{x_{n} = W} \rho(x) dx = qA \int_{0}^{W} N_{D}(x) dx$$

junction will be

Assuming the diode follows the applied a.c. signal quasistatically,

$$C_{\rm J} = \frac{dQ_{\rm P}}{dV_{\rm A}} = -\frac{dQ_{\rm N}}{dV_{\rm A}} = -qA\frac{d}{dV_{\rm A}} \int_0^W N_{\rm D}(x)dx = -qAN_{\rm D}(W)\frac{dW}{dV_{\rm A}}$$

However,

$$C_{\rm J} = \frac{K_{\rm S} \varepsilon_0 A}{W}$$

$$\frac{dC_{\rm J}}{dV_{\rm A}} = -\frac{K_{\rm S} \varepsilon_0 A}{W^2} \frac{dW}{dV_{\rm A}}$$

and therefore

$$\frac{dW}{dV_{A}} = -\frac{W^{2}}{K_{S}\varepsilon_{0}A} \frac{dC_{J}}{dV_{A}} = -\frac{K_{S}\varepsilon_{0}A}{C_{I}^{2}} \frac{dC_{J}}{dV_{A}}$$

Substituting back into the generalized capacitance expression then yields

$$C_{\rm J} = -qAN_{\rm D}(W)\frac{dW}{dV_{\rm A}} = \frac{qK_{\rm S}\varepsilon_0A^2N_{\rm D}(W)}{C_{\rm J}^2}\frac{dC_{\rm J}}{dV_{\rm A}}$$

and solving for $N_D(W)$ gives

$$N_{\rm D}(W) = \frac{1}{qK_{\rm S}\varepsilon_0 A^2 \left[(dC_{\rm J}/dV_{\rm A})/C_{\rm J}^3 \right]}$$

Finally, noting

$$\frac{d}{dV_{A}} \left(\frac{1}{C_{J}^{2}} \right) = -\frac{2}{C_{J}^{3}} \frac{dC_{J}}{dV_{A}}$$

and realizing W is synonymous with the distance x from the junction being probed, we obtain

$$N_{\rm D}(x) = \frac{2}{qK_{\rm S}\varepsilon_0 A^2 d(1/C_{\rm J}^2)/dV_{\rm A}}$$

where

$$x = W = \frac{K_S \varepsilon_0 A}{C_J}$$
 ... (from $C_J = K_S \varepsilon_0 A/W$)

7.6 (Solution not supplied.)

7.7 As deduced by combining Eqs. (7.29) and (7.30),

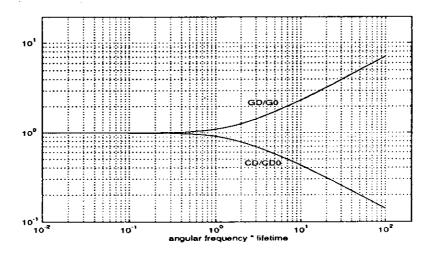
$$G_{\rm D}/G_0 = \frac{1}{\sqrt{2}} \left(\sqrt{1 + \omega^2 \tau_{\rm p}^2} + 1 \right)^{1/2}$$

$$C_{\rm D}/C_{\rm D0} = \frac{\sqrt{2}}{\omega \tau_{\rm p}} \left(\sqrt{1 + \omega^2 \tau_{\rm p}^2} - 1 \right)^{1/2}$$

Computations based on the above relationships and implemented using the program listed below yield an almost perfect reproduction of the text plot.

MATLAB program script...

```
% Frequency variation of the normalized diffusion
% conductance (GD/GO) and capacitance (CD/CDO)
% (reproduction of Fig. 7.10)
%Initialization
clear:
        close
%Computation
x=logspace(-2,2);
Gratio=sqrt(sqrt(1+x.^2)+1)./sqrt(2);
Cratio=sqrt(sqrt(1+x.^2)-1).*(sqrt(2)./x);
%Plot
loglog(x,Gratio,x,Cratio);
axis([0.01,200,0.1,20]);
xlabel('angular frequency * lifetime')
text(2.4,2.2,'GD/G0')
text (2.2, 0.45, 'CD/CD0')
```



As deduced by combining Eqs. (7.30a) and (7.30b),

$$\omega C_{\rm D}/G_{\rm D} \rightarrow \omega \tau_{\rm p}/2$$
 ... $\omega \tau_{\rm p} << 1$

As deduced from Eqs. (7.29a) and (7.29b),

$$C_{\rm D} \rightarrow \frac{G_0}{\omega \sqrt{2}} \sqrt{\omega \tau_{\rm p}}$$
 ... $\omega \tau_{\rm p} >> 1$

$$G_{\rm D} \rightarrow \frac{G_0}{\sqrt{2}} \sqrt{\omega \tau_{\rm p}} \qquad ... \omega \tau_{\rm p} >> 1$$

and

$$\omega C_{\rm D}/G_{\rm D} \rightarrow 1$$
 ... $\omega \tau_{\rm p} >> 1$

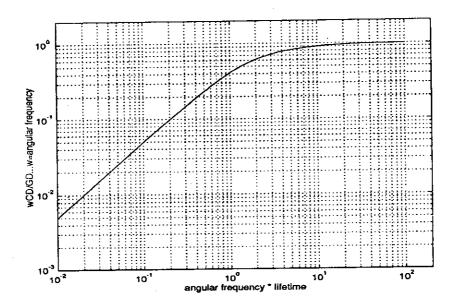
In general, again referring to Eqs. (7.29),

$$\frac{\omega C_{\rm D}}{G_{\rm D}} = \left(\frac{\sqrt{1 + \omega^2 \tau_{\rm p}^2} - 1}{\sqrt{1 + \omega^2 \tau_{\rm p}^2} + 1} \right)^{1/2}$$

A plot of $\omega C_D/G_D$ versus $\omega \tau_p$ that is consistent with the limiting-case solutions and the script of the generating MATLAB program are displayed below. The result here provides some food for thought. Even though G_D increases and C_D decreases with increased frequency above $\omega \tau_p = 1$, the relative size of the real and imaginary components of the diffusion admittance approach the same value and increase at the same rate if $\omega \tau_p >> 1$. Also, the result emphasizes that the diffusion conductance is the larger admittance component at low frequencies.

MATLAB program script...

```
% Relative size of the capacitive and conductive
% components of the diffusion admittance (wCD/GD)
%Initialization
clear; close
%Computation
x=logspace(-2,2);
ratio=sqrt((sqrt(1+x.^2)-1)./(sqrt(1+x.^2)+1));
%Plot
loglog(x,ratio);
axis([0.01,200,0.001,2]); grid
xlabel('angular frequency * lifetime')
ylabel('wCD/GD...w=angular frequency')
```



7.9 A table listing the computational variables and the deduced values of τ_n is presented below. Capacitance entries in this table were established as follows:

- (1) The $C_{\rm TOTAL} = C_{\rm J} + C_{\rm D}$ data spanning the voltage range from 0.5V to 0.58V were extracted from line 20 of the MATLAB program script in Exercise 7.4.
- (2) $C_{\rm J}$ was computed using

$$C_{\rm J} = C_{\rm J0}/\sqrt{1 - V_{\rm A}/V_{\rm bi}} = 120/\sqrt{1 - V_{\rm A}/0.7}$$
 (pF)

The values of $C_{\rm J0}$ and $V_{\rm bi}$ were noted from entries in the Exercise 7.4 program script.

(3)
$$C_D = C_{TOTAL} - C_J$$

| $V_{\rm A}$ (volts) | $C_{\text{TOTAL}}(pF)$ | $C_{\rm J}$ (pF) | $C_{\rm D}$ (pF) | $G_{\mathrm{D}}\left(\mathbb{S}\right)$ | $\tau_{\rm n} = 2C_{\rm D}/G_{\rm D} \; ({\rm sec})$ |
|---------------------|------------------------|------------------|------------------|--|--|
| 0.5 | 276 | 224 | 52 | 2.00×10 ⁻⁴ | 5.20×10-7 |
| 0.52 | 346 | 237 | 109 | 3.90×10 ⁻⁴ | 5.59×10-7 |
| 0.54 | 440 | 251 | 189 | 7.15×10 ⁻⁴ | 5.29×10-7 |
| 0.56 | 654 | 268 | 386 | 1.33×10 ⁻³ | 5.81×10-7 |
| 0.58 | 938 | 290 | 648 | 2.28×10 ⁻³ | 5.68×10-7 |

$$\overline{\tau_n} = 5.51 \times 10^{-7} \text{ sec}$$